



ORIENT

Photo copier

Product Data Sheet

Part Number: ORPC-817-(GK)

Comment: _____

Date: _____

一级代理商：

深圳市弗瑞鑫电子有限公司

地址：深圳市宝安区西乡大道302号金源商务大厦B座三楼

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- (1) Current transfer ratio (CTR : MIN. 50% at $I_F = 5\text{mA}$, $V_{CE} = 5\text{V}$)
- (2) High input isolation voltage ($V_{i_o} = 5,000\text{V}_{\text{rms}}$)
- (3) Response time (tr : TYP. 2.9 μs at $V_{CE} = 2\text{V}$, $I_C = 2\text{mA}$, $R_L = 100\ \Omega$)
- (4) ESD protection HBM 3000V/MM 2000V
- (5) Safe approach

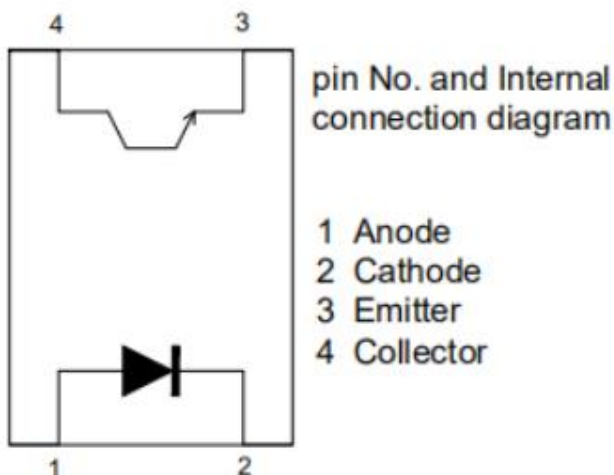
- UL approved (No.E323844)
- VDE approved (No.40029733)
- CQC approved (No.CQC09001029446)
- CE approved (No.AC/0431008)
- Sa e Grid approved (No.SGCM01300170152)

- (6) In compliance with RoHS, REACH standards
- (7) MSL Class 1



- (1) ORPC-817-(GK) photo coupler consists of one piece of GaAs emitter and one piece of NPN transistor.
- (2) Packaged in a 4-pin DIP package and available in side-lead packaging and SMD option.

- (1) Switching power supply
- (2) Ammeter
- (3) Computer
- (4) Industrial application, measuring machine
- (5) Signal waveform generator
- (6) Imbalance equipment, duplicating machine, automatic
- (7) Family electronic equipment, chaff





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| | | | | | | | |
|--|--|-------------|-------------------|-------------------|-----|----|--|
| | | | | | | | |
| | For ard Vol age | V_F | --- | 1.2 | 1.4 | V | $I_F=20mA$ |
| | Re er e C rren | I_R | --- | --- | 5 | A | $V_R=5V$ |
| | Inp Capaci ance | C | --- | 10 | 200 | pF | $V=0, f=1MH$ |
| | Dark C rren | I_{CEO} | --- | --- | 100 | nA | $V_{CE}=20V$ $I_F=0mA$ |
| | Collec or and Emi er a en a ion Vol age | BV_{CEO} | 80 | --- | --- | V | $I_C=0.1mA$ $I_F=0mA$ |
| | Emi er and Collec or a en a ion Vol age | BV_{ECO} | 7 | --- | --- | V | $I_E=0.1mA$ $I_F=0mA$ |
| | *1 C rren ran fer ra io | CTR | 50 | --- | 600 | % | $I_F=5mA$ $V_{CE}=5V$ |
| | Collec or C rren | I_C | 2.5 | --- | 30 | mA | $I_F=5mA$ $V_{CE}=5V$ |
| | Collec or and Emi er Sa ra ion Vol age | $V_{CE(a)}$ | --- | 0.1 | 0.2 | V | $I_F=20mA$ $I_C=1mA$ |
| | I ola ion Impedance | $R_{i o}$ | $5 \cdot 10^{10}$ | $1 \cdot 10^{12}$ | --- | | DC500V 40 60%R.H. |
| | Floa ing Capaci ance | C_f | --- | 0.4 | 1.0 | pF | $V=0, f=1MH$ |
| | C -off Freq enc | f_c | --- | 260 | --- | kH | $V_{CE}=5V$ $I_C=2mA$ $R_L=100 \Omega, -3dB$ |
| | Ri e Time | t_r | --- | 2.9 | 10 | | $V_{CC}=2V$ $I_C=2mA$ $R_L=100 \Omega$ |
| | Fall Time | t_f | --- | 4.5 | 10 | | |
| | T rn-on Time | t_{on} | --- | 6.3 | 10 | | |
| | T rn-off Time | t_{off} | --- | 7.1 | 10 | | |

*1 C rren Con er ion Ra io = I_C / I_F 100% , CTR Tolerance: 3%.



| | | | | |
|---|-----|-----|------------------------------|---|
| | | | | |
| L | 50 | 100 | $I_F=5mA, V_{CE}=5V, T_a=25$ | % |
| A | 80 | 160 | | |
| B | 130 | 260 | | |
| C | 200 | 400 | | |
| D | 300 | 600 | | |

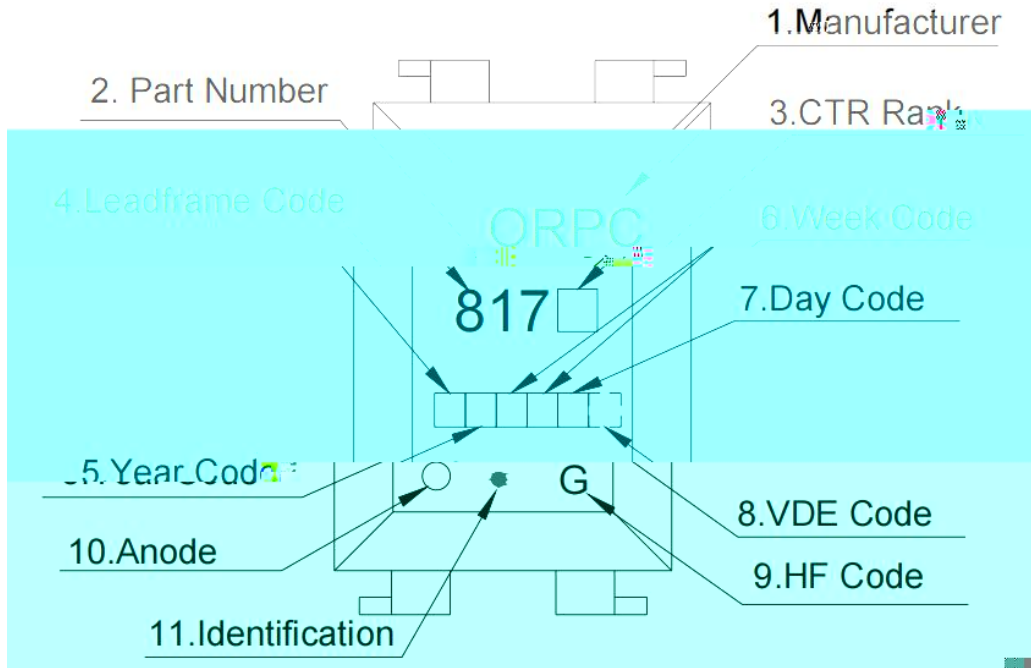
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|----|-----|-----|--------------------------------|---|
| | | | | |
| A5 | 4 | 20 | $I_F=0.1mA, V_{CE}=5V, T_a=25$ | % |
| B5 | 6.5 | 34 | | |
| C5 | 10 | 52 | | |
| D5 | 15 | 78 | | |
| A6 | 24 | 72 | $I_F=0.5mA, V_{CE}=5V, T_a=25$ | |
| B6 | 40 | 120 | | |
| C6 | 70 | 140 | | |
| D6 | 90 | 270 | | |
| A7 | 40 | 105 | $I_F=1mA, V_{CE}=5V, T_a=25$ | |
| B7 | 65 | 170 | | |
| C7 | 100 | 260 | | |
| D7 | 150 | 390 | | |



X = Lead form op ion (S, M or none)

T = CTR Rank (L, A, B, C, D, A5, B5, C5...)

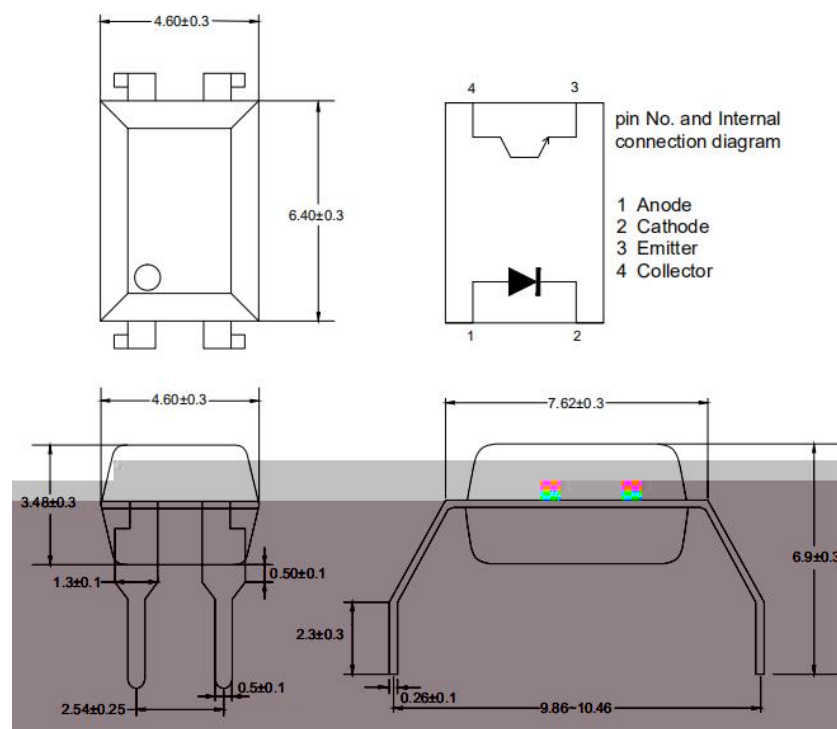
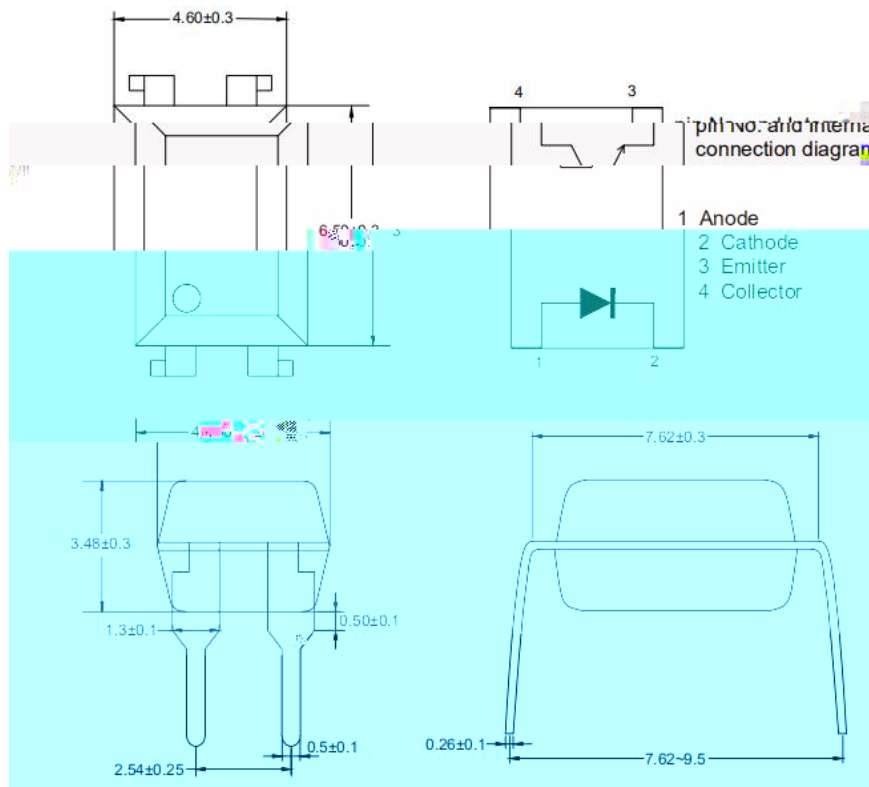
V = Tam B



- (1) ORIENT PHOTO COUPLER.
- (2) 817 denoted Device Part Number.
- (3) [] denoted Rank Code. (Number no mark, L,A,B,C or D only)
(For example C6 marked C only)
- (4) [] denoted Lead Frame Code.
- (5) [] denoted Year Code.
- (6) [][] denoted Week Code.
- (7) [] denoted Day Code.
- (8) [] denoted VDE Code. (Optional)
- (9) [] denoted HF Code. (Copper for HF only)
- (10) Anode.
- (11) Identification.

* VDE Mark can be selected.

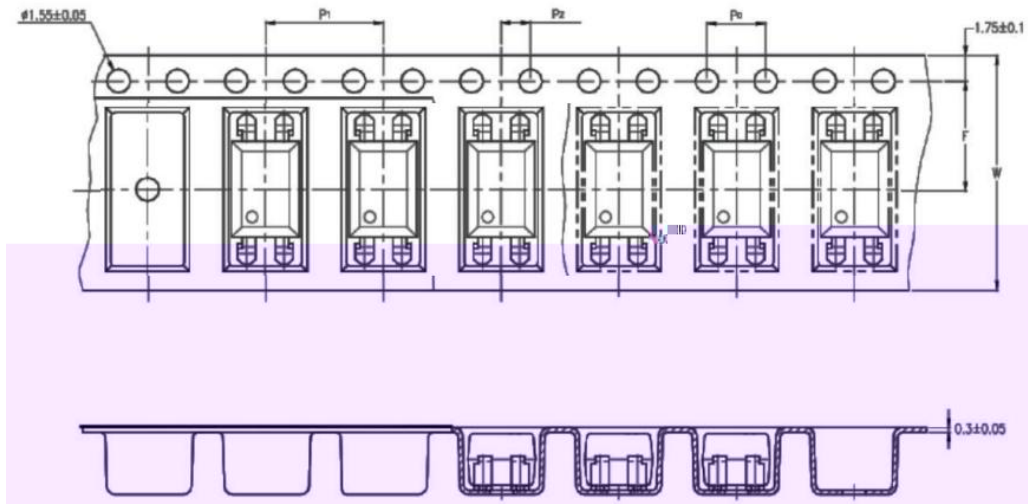
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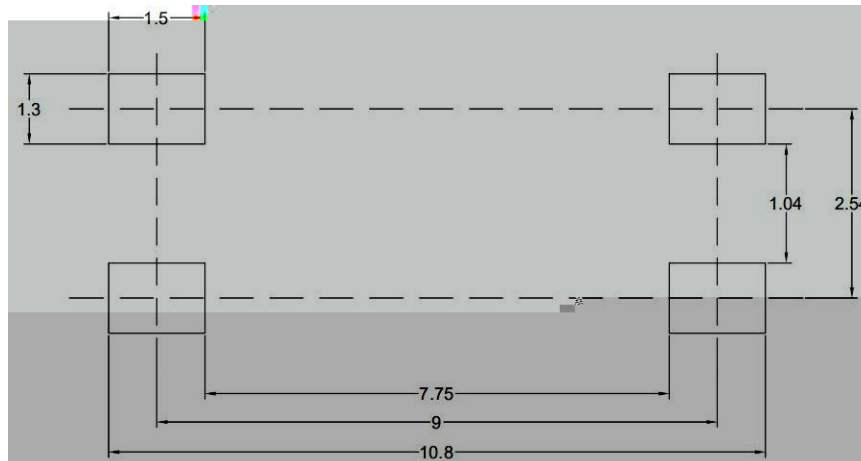
ORPC-817-(GK)



| | | |
|--|-------|-------------------|
| Tape width | W | 16.0 ± 0.3 (.63) |
| Pitch of sprocket hole | P_0 | 4.0 ± 0.1 (.15) |
| Distance of sprocket hole | F | 7.5 ± 0.1 (.295) |
| | P_2 | 2.0 ± 0.1 (.0079) |
| Distance of sprocket hole of sprocket hole | P_1 | 8.0 ± 0.1 (.472) |

| | |
|---------------|--------|
| Package Type | TP/TP1 |
| Quantity (pc) | 2000 |

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| | | Reliability Testing | | | | |
|----|----------------------------|---------------------|--|--------------|-----------------------|-------------|
| | | | | | | |
| 1 | 耐焊接热 | 22 | 260±5℃ | 10 /3 次 | 锡炉 | JESD22-A106 |
| 2 | 高温存储 | 77 | 125℃ | 168 hr | 高温烤箱 测试仪 | JESD22-A103 |
| | | | | 500 hr | | |
| | | | | 1000 hr | | |
| 3 | 低温存储 | 77 | -55℃ | 168 hr | 低温箱 测试仪 | JESD22-A119 |
| | | | | 500 hr | | |
| | | | | 1000 hr | | |
| 4 | 温度循环 | 77 | H:125℃ 15min ∫ 5min L:-55℃ 15min | 300 c cle | 冷热冲击机 | JESD22-A104 |
| 5 | 温度冲击 | 77 | H:100℃ 5min ∫ 15 L:-40℃ 5min | 300 c cle | 冷热冲击机 | JESD22-A106 |
| 6 | 高温操作 | 77 | 110℃ IF=10mA Vce=5V | 168 hr | 高温烤箱 测试仪、老 化电路板 | JESD22-A108 |
| | | | | 500 hr | | |
| | | | | 1000 hr | | |
| 7 | 人体模式 | 22 | ≥8KV 1C cle | 1次 | ESD静电测 试仪 | JESD22-A114 |
| 8 | 可焊性 | 22 | Pb-free 245±5℃ | 5S/1次 | 锡炉 | JESD22-B102 |
| 9 | HTRB 高温反向偏压 | 77 | HTRB @125℃ Vce=80 | 168 hr | 高温烤箱 , 测试仪 | JESD22-A103 |
| | | | | 500 hr | | |
| | | | | 1000 hr | | |
| 10 | H3TRB 温湿度反向偏 压, 寿命试验 | 77 | H3TRB 85℃,85%RH Vce=80 | 168 hr | 恒温恒湿 机, 测试仪 | JESD22-A101 |
| | | | | 500 hr | | |
| | | | | 1000 hr | | |
| 11 | Autoclave 压力锅 | 77 | Ta=121 ℃,100%RH,2a m | 96hr | 压力锅 | JESD22-A102 |



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Fig.1 Forward current vs Ambient temperature

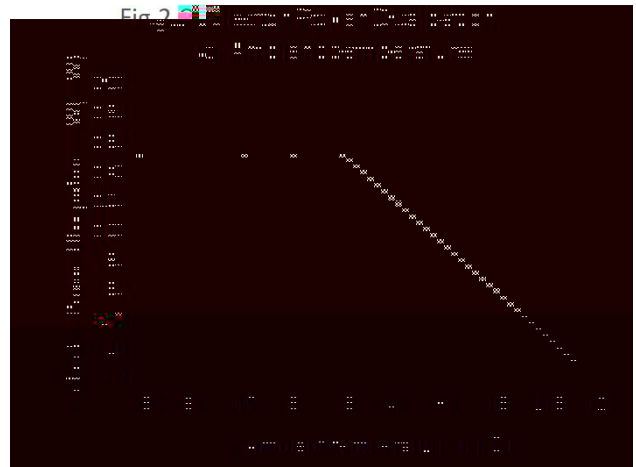
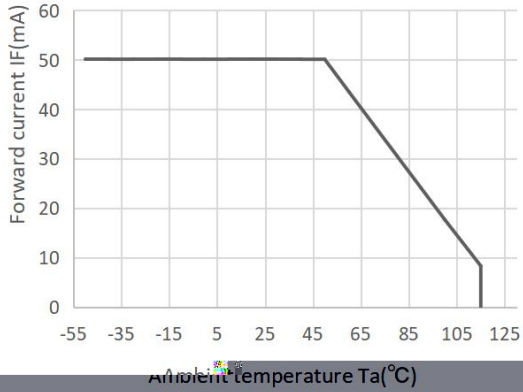


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

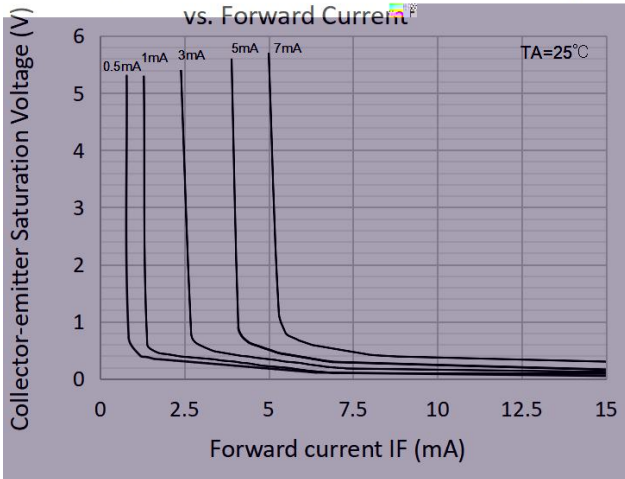


Fig.4 Forward Current vs. Forward Voltage

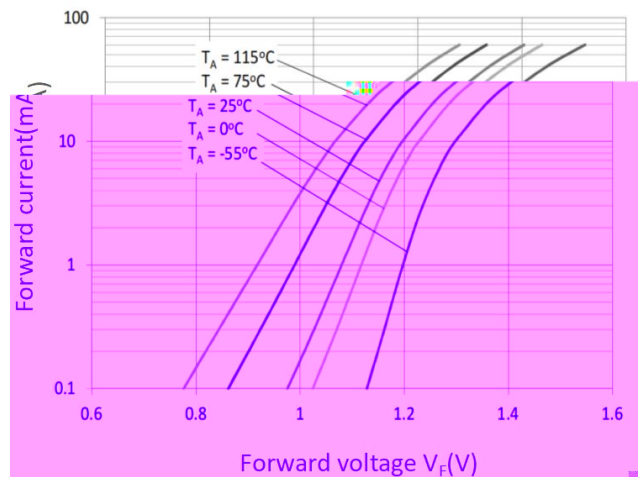


Fig.5 Forward Current vs. Current Transfer Ratio

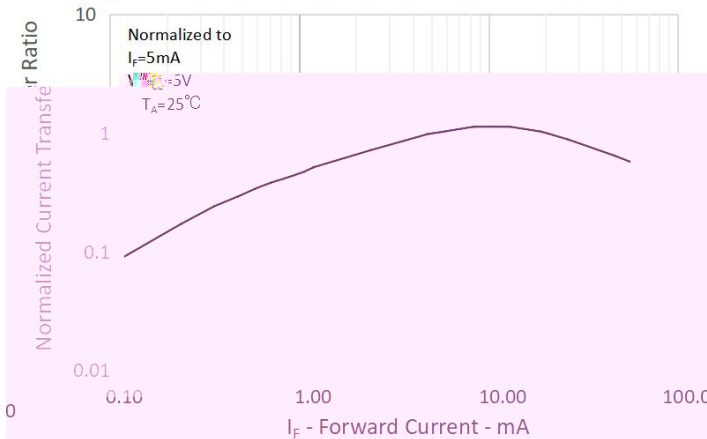


Fig.6 Collector Current vs. Collector-emitter Voltage

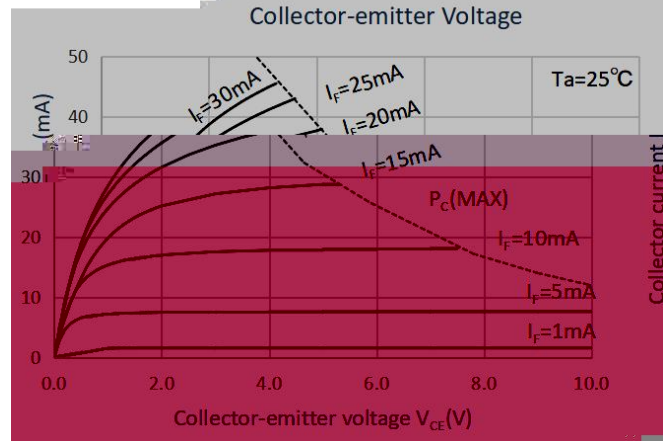


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

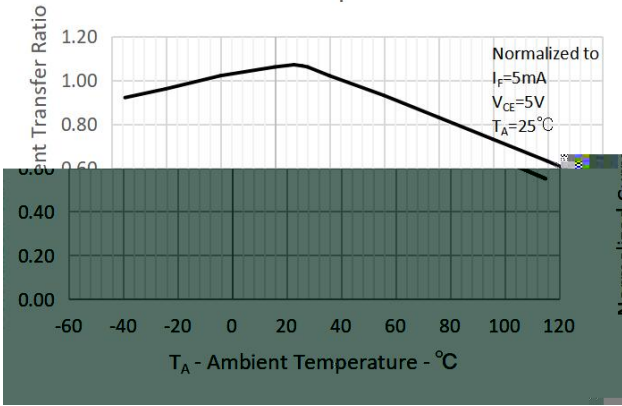


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

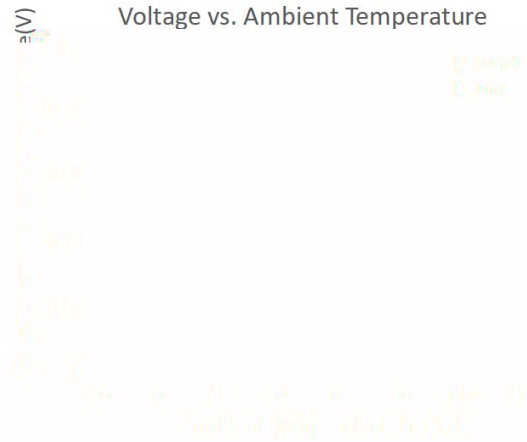


Fig.9 Collector Dark Current vs. Ambient Temperature



Fig.10 Respnse Time vs. Load Resistance

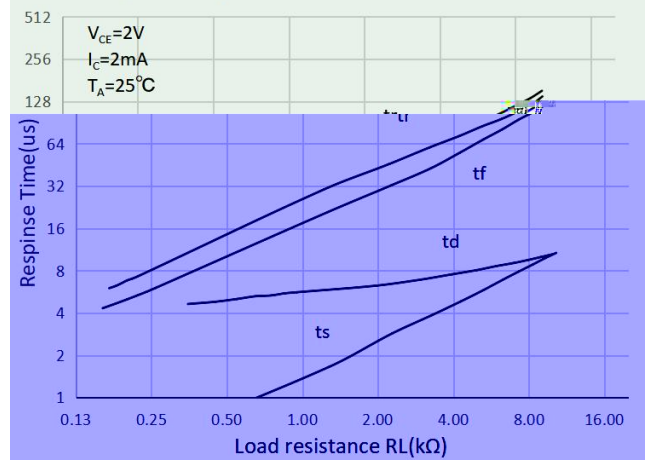
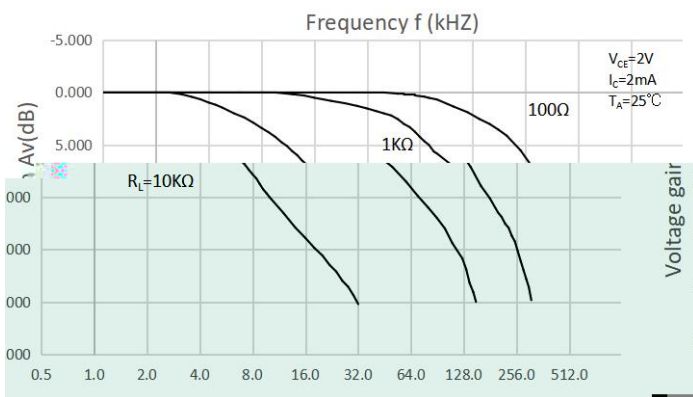
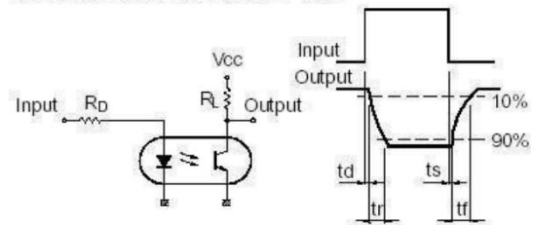


Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response

